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REFERENCES	

NAME OF INVENTOR(S): Srinivasan Chakravarthi, et al.		RECEIPT DATE & SERIAL NO.: Serial No.:
TITLE OF INVENTION: Fabrication of Ultra Shallow Junctions from a Solid Source with Fluorine Implantation		
TI FILE NO.: TI-33161.2	DEPOSIT ACCT. NO.: 20-0668	
EXPRESS MAIL RECEIPT NO. EV334469445US MLD: 10-2-03 DUE: --- ATTY/SEC'Y: RAK/kjv		

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